



## Advances in Micro and Nanomanufacturing

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Deadline for manuscript  
submissions:

**closed (15 October 2021)**

### Message from the Guest Editor

There is an increasing interest in the potential of micro- and nanomanufacturing in numerous scientific and technological sectors. At the same time, micro- and nanomanufacturing present great challenges to engineers and researchers. From a manufacturing point of view, such processing technologies are at a relative early stage of development. Key enabling technologies, sourced from the Industry 4.0 KETs era, offer a great potential for mastering micro- and nanomanufacturing-related processes. In this Special Issue of *JMMP*, current research findings will be reported, focusing on micro- and nanomanufacturing and/or manufacturing parts with micro/nano features. More specifically, retrieval and utilization of information related to process modeling and monitoring is of great interest, as well as experimental works that build up knowledge regarding the process itself. The considered papers should support the achievement of significant improvements with clear regard to aspects of manufacturing attributes.





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### Message from the Editor-in-Chief

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